

FODM3011, FODM3012, FODM3022, FODM3023, FODM3052, FODM3053

4-Pin Full Pitch Mini-Flat Package Random-Phase Triac Driver Output Optocouplers

Features

- Compact 4-pin surface mount package (2.4 mm maximum standoff height)
- Peak blocking voltage
250V (FODM301X)
400V (FODM302X)
600V (FODM305X)
- Available in tape and reel quantities of 2500.
- Add "NF098" for new construction version with 260°C max. reflow temperature rating
- UL, C-UL and VDE certifications pending

Applications

- Industrial controls
- Traffic lights
- Vending machines

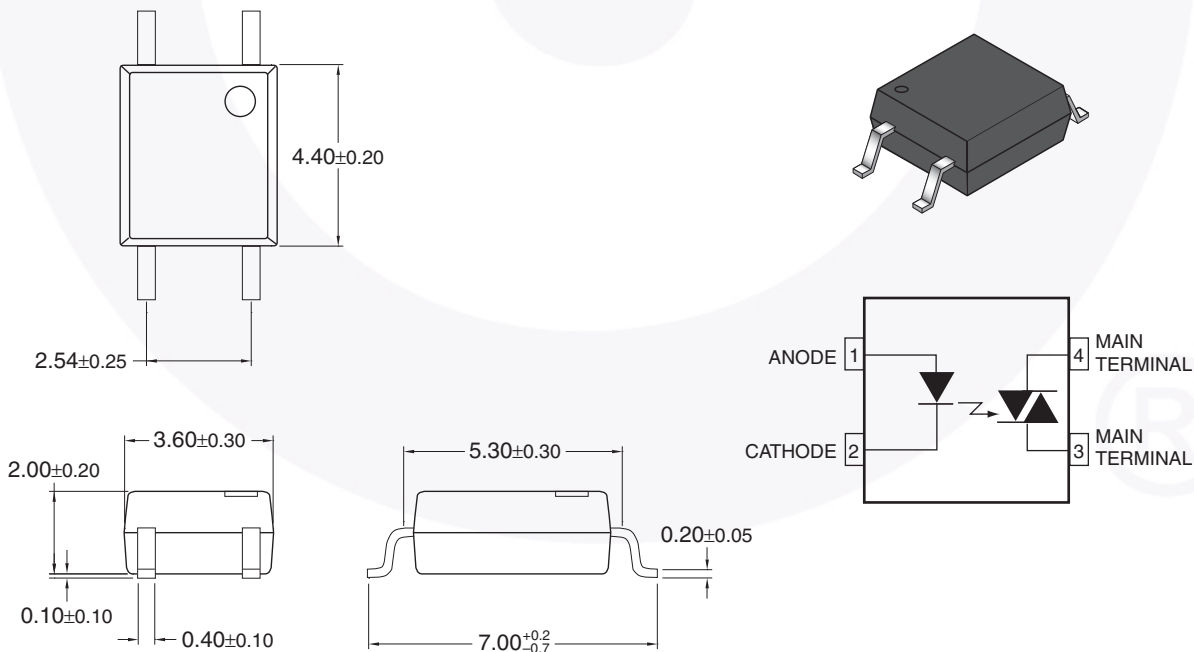
Applications (Continued)

- Solid state relay
- Lamp ballasts
- Solenoid/valve controls
- Static AC power switch
- Incandescent lamp dimmers
- Motor control

Description

The FODM301X, FODM302X, and FODM305X series consists of a GaAs infrared emitting diode driving a silicon bilateral switch housed in a compact 4-pin mini-flat package. The lead pitch is 2.54mm. They are designed for interfacing between electronic controls and power triacs to control resistive and inductive loads for 115V/240V operations.

Package Dimensions



Note:

All dimensions are in millimeters.

Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$ unless otherwise specified)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol | Parameter | Value | Units |
|----------------------|---|-------------------|------------------|
| TOTAL PACKAGE | | | |
| T_{STG} | Storage Temperature | -55 to +150 | $^\circ\text{C}$ |
| T_{OPR} | Operating Temperature | -40 to +100 | $^\circ\text{C}$ |
| EMITTER | | | |
| I_F (avg) | Continuous Forward Current | 60 | mA |
| I_F (pk) | Peak Forward Current (1 μs pulse, 300pps.) | 1 | A |
| V_R | Reverse Input Voltage | 3 | V |
| P_D | Power Dissipation (No derating required over operating temp. range) | 100 | mW |
| DETECTOR | | | |
| $I_{T(RMS)}$ | On-State RMS Current | 70 | mA (RMS) |
| V_{DRM} | Off-State Output Terminal Voltage | FODM3011/FODM3012 | 250 |
| | | FODM3022/FODM3023 | 400 |
| | | FODM3052/FODM3053 | 600 |
| P_D | Power Dissipation (No derating required over operating temp. range) | 300 | mW |

Electrical Characteristics ($T_A = 25^\circ\text{C}$)**Individual Component Characteristics**

| Symbol | Parameter | Test Conditions | Device | Min. | Typ.* | Max. | Unit |
|------------------|--|---|---|-------|-------|------|------------------|
| EMITTER | | | | | | | |
| V_F | Input Forward Voltage | $I_F = 10\text{mA}$ | All | | 1.20 | 1.5 | V |
| I_R | Reverse Leakage Current | $V_R = 3\text{V}, T_A = 25^\circ\text{C}$ | All | | 0.01 | 100 | μA |
| DETECTOR | | | | | | | |
| I_{DRM} | Peak Blocking Current Either Direction | Rated $V_{\text{DRM}}, I_F = 0^{(1)}$ | All | | 2 | 100 | nA |
| dV/dt | Critical Rate of Rise of Off-State Voltage | $I_F = 0$ (Figure 8) ⁽²⁾ | FODM3011, FODM3012, FODM3022, FODM3023 | | 10 | | V/ μs |
| | | | FODM3052, FODM3053 | 1,000 | | | |

Transfer Characteristics

| Symbol | DC Characteristics | Test Conditions | Device | Min. | Typ.* | Max. | Unit |
|-----------------|--|---|------------------------------------|------|-------|------|---------------|
| I_{FT} | LED Trigger Current | Main Terminal Voltage = $3\text{V}^{(3)}$ | FODM3011, FODM3022, FODM3052 | | | 10 | mA |
| | | | FODM3012, FODM3023, FODM3053 | | | 5 | |
| I_H | Holding Current, Either Direction | | All | | 300 | | μA |
| V_{TM} | Peak On-State Voltage Either Direction | $I_{\text{TM}} = 100\text{mA}$ peak | All | | 1.7 | 3 | V |

Isolation Characteristics

| Symbol | Characteristic | Test Conditions | Device | Min. | Typ.* | Max. | Unit |
|------------------|--------------------------------|--------------------------------|--------|------|-------|------|------|
| V_{ISO} | Steady State Isolation Voltage | 1 Minute, R.H. = 40% to 60% | All | 3750 | | | VRMS |

*All typicals at $T_A = 25^\circ\text{C}$ **Notes:**

1. Test voltage must be applied within dv/dt rating.
2. This is static dv/dt. See Figure 1 for test circuit. Commutating dv/dt is function of the load-driving thyristor(s) only.
3. All devices are guaranteed to trigger at an I_F value less than or equal to max I_{FT} . Therefore, recommended operating I_F lies between max I_{FT} (10mA for FODM3011, FODM3022, and FODM3052, 5mA for FODM3012, FODM3023, and FODM3053) and absolute max I_F (60mA).

Typical Performance Curves

Fig. 1 LED Forward Voltage vs. Forward Current

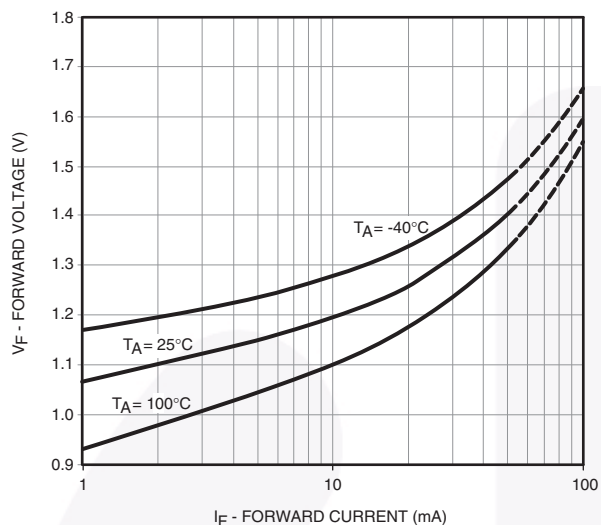


Fig. 2 Leakage Current vs. Ambient Temperature

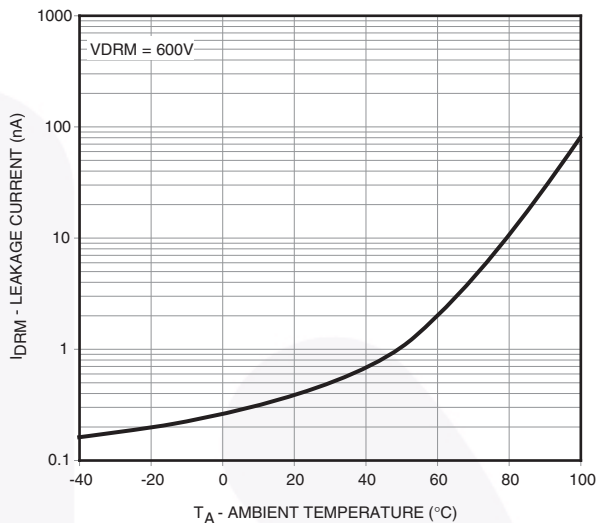


Fig. 3 Holding Current vs. Ambient Temperature

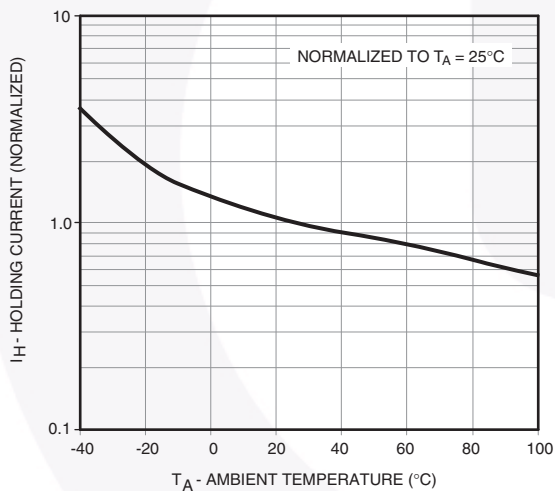
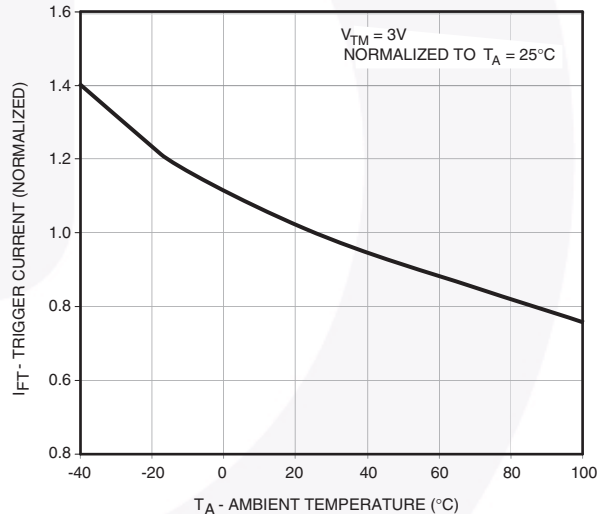


Fig. 4 Trigger Current vs. Ambient Temperature



Typical Performance Curves (Continued)

Fig. 5 LED Current Required to Trigger vs. LED Pulse Width

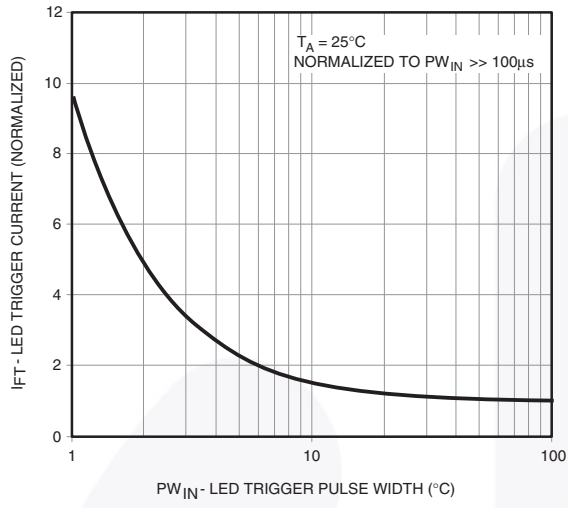


Fig. 6 Off-State Output Terminal Voltage vs. Ambient Temperature

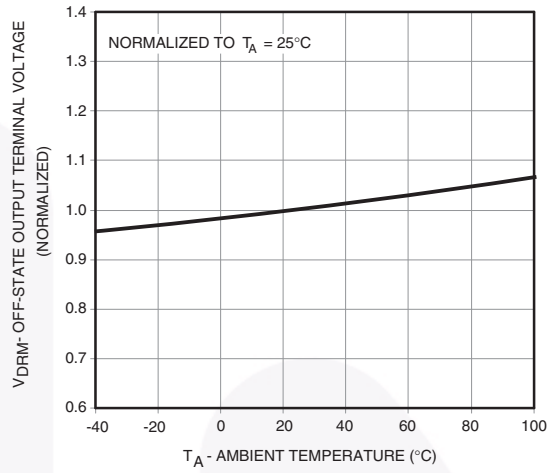
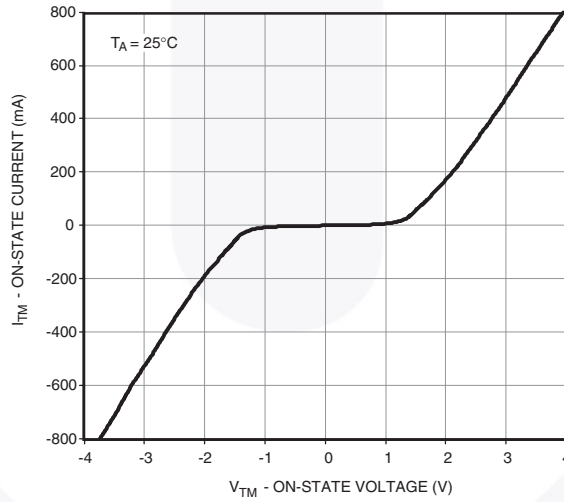


Fig. 7 On-State Characteristics



Typical Application Information

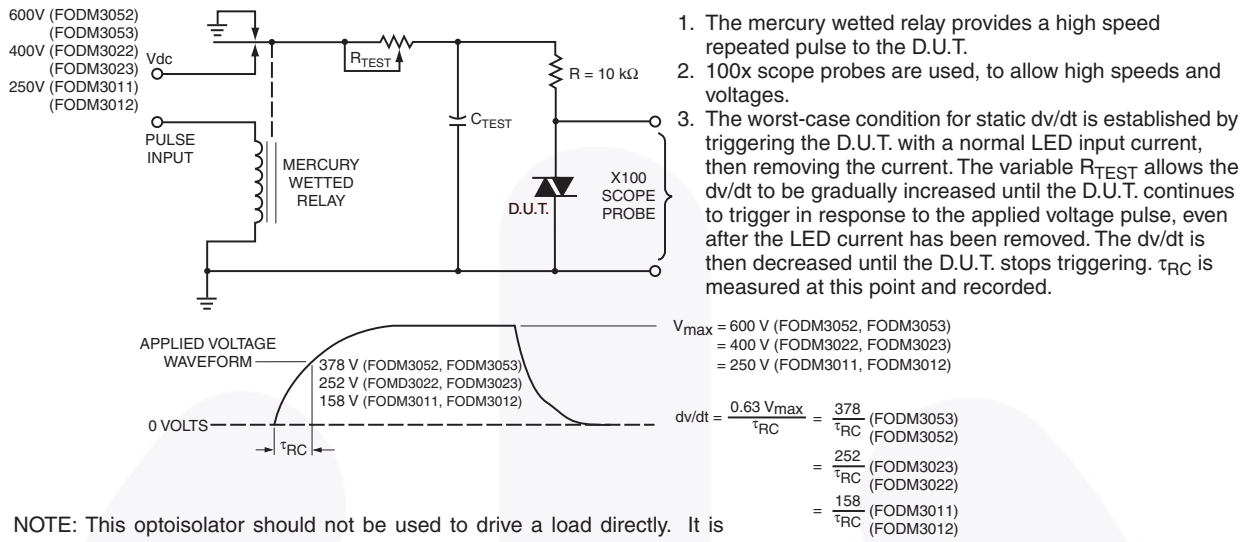


Figure 8. Static dv/dt Test Circuit

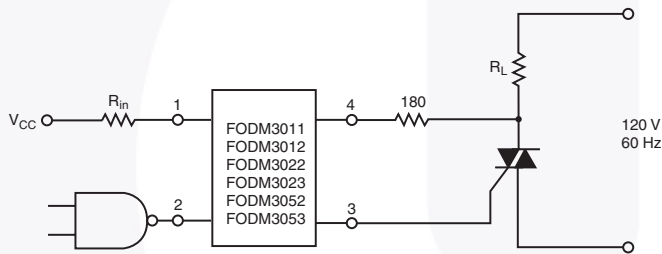


Figure 9. Resistive Load

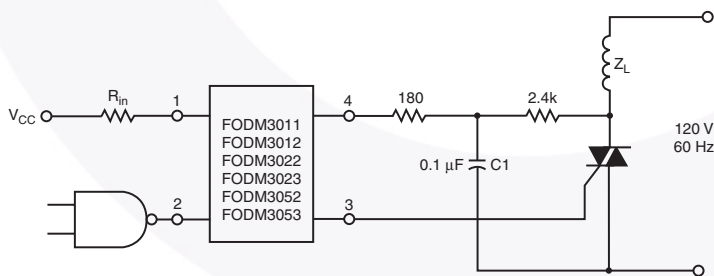
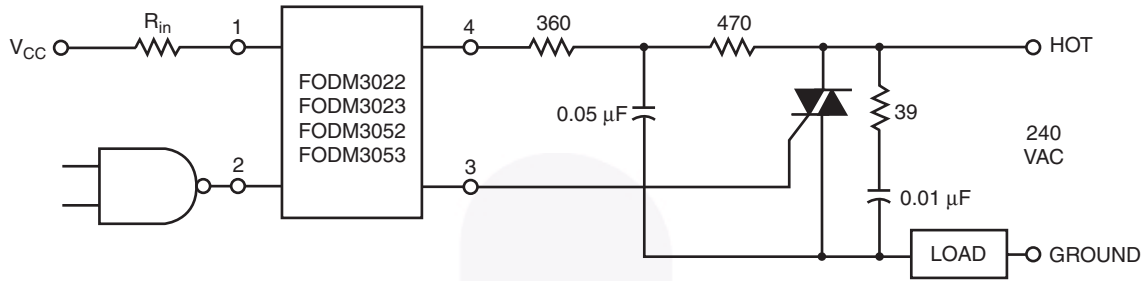


Figure 10. Inductive Load with Sensitive Gate Triac ($I_{GT} \leq 15 \text{ mA}$)

Typical Application Information (Continued)



In this circuit the “hot” side of the line is switched and the load connected to the cold or ground side.

The $39\ \Omega$ resistor and $0.01\ \mu\text{F}$ capacitor are for snubbing of the triac, and the $470\ \Omega$ resistor and $0.05\ \mu\text{F}$ capacitor are for snubbing the coupler. These components may or may not be necessary depending upon the particular and load used.

Figure 11. Typical Application Circuit

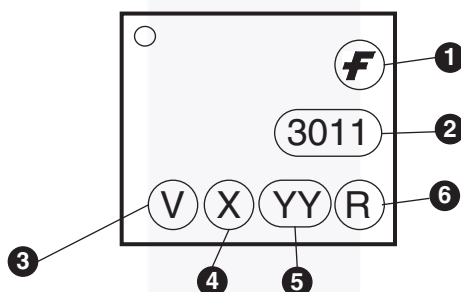
Ordering Information

| Option | Description |
|-----------|---|
| V_NF098 | VDE Approved |
| R2_NF098 | Tape and Reel (2500 units) |
| R2V_NF098 | Tape and Reel (2500 units) and VDE Approved |

Note:

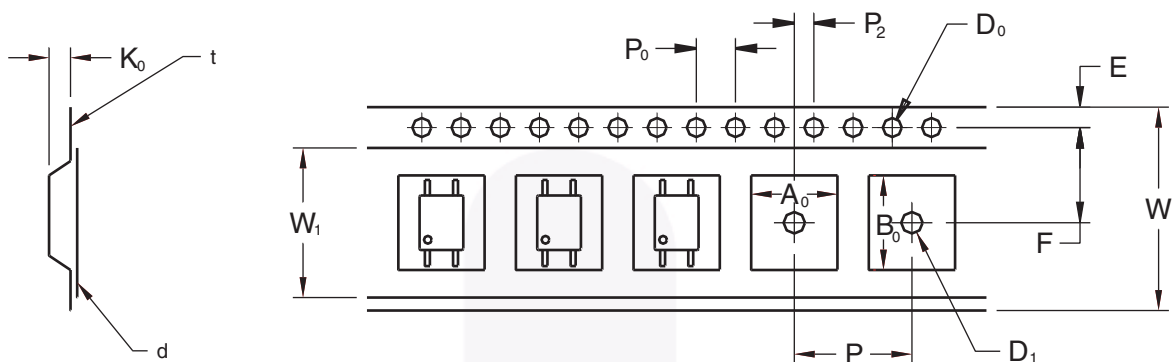
To specify the new construction version with 260°C max reflow peak temperature rating: Add "NF098" to the end of the part number. The non NF098 version is rated for 230°C peak reflow temperature.

Marking Information



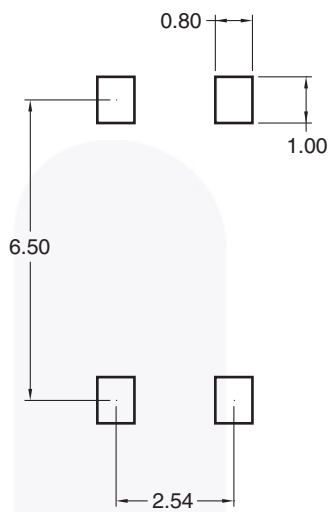
| Definitions | |
|-------------|--|
| 1 | Fairchild logo |
| 2 | Device number |
| 3 | VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table) |
| 4 | One digit year code |
| 5 | Two digit work week ranging from '01' to '53' |
| 6 | Assembly package code |

Tape Specifications



| | | 2.54 Pitch |
|---------------------------------|----------------|--------------|
| Description | Symbol | Dimensions |
| Tape Width | W | 12.00±0.4 |
| Tape Thickness | t | 0.35±0.02 |
| Sprocket Hole Pitch | P ₀ | 4.00±0.20 |
| Sprocket Hole Dia. | D ₀ | 1.55±0.20 |
| Sprocket Hole Location | E | 1.75±0.20 |
| Pocket Location | F | 5.50±0.20 |
| | P ₂ | 2.00±0.20 |
| Pocket Pitch | P | 8.00±0.20 |
| Pocket Dimension | A ₀ | 4.75±0.20 |
| | B ₀ | 7.30±0.20 |
| | K ₀ | 2.30±0.20 |
| Pocket Hole Dia. | D ₁ | 1.55±0.20 |
| Cover Tape Width | W ₁ | 9.20 |
| Cover Tape Thickness | d | 0.065±0.02 |
| Max. Component Rotation or Tilt | | 20° max |
| Devices Per Reel | | 2500 |
| Reel Diameter | | 330 mm (13") |

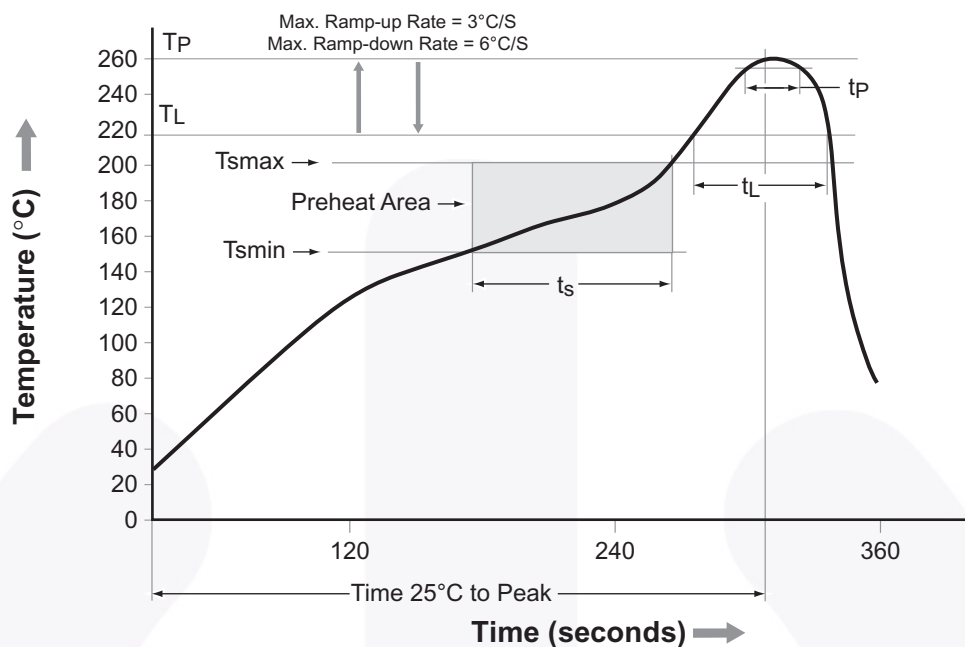
Footprint Drawing for PCB Layout



Note:
All dimensions are in mm.



Reflow Profile








| Profile Feature | Pb-Free Assembly Profile |
|---------------------------------|--------------------------|
| Temperature Min. (Tsmín) | 150°C |
| Temperature Max. (Tsmáx) | 200°C |
| Time (ts) from (Tsmín to Tsmáx) | 60–120 seconds |
| Ramp-up Rate (tL to tp) | 3°C/second max. |
| Liquidous Temperature (TL) | 217°C |
| Time (tL) Maintained Above (TL) | 60–150 seconds |
| Peak Body Package Temperature | 260°C +0°C / -5°C |
| Time (tp) within 5°C of 260°C | 30 seconds |
| Ramp-down Rate (TP to TL) | 6°C/second max. |
| Time 25°C to Peak Temperature | 8 minutes max. |



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